



喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
 7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
 TAMSHUI, TAIPEI, TAIWAN, R.O.C.



TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677
<http://www.chyaoshiunn.com.tw> E-mail: cs@chyaoshiunn.com.tw

Type Document	Product Specification	Revised /Edition	L
Date Issued	2010/03/05	Data Revised	2022/07/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			
			Engineering Dept.

This specification is referred to 2.54 mm DIP series Flat Cable to board connector.

本規格書內容係提供 2.54 mm DIP 牛角系列產品相關參考，

其用途為排線端相接於電路板端連接器

-INDEX-

- 1.0 Product Name/Part Number & Drawing Number. (產品名稱 / 產品型號及圖面型號)
- 2.0 Construction/Dimensions/Material & Surface Finish. (材質以及表面鍍層)
- 3.0 Characteristic. (產品特性)
- 4.0 Specimen. (樣本圖示)
- 5.0 Applicable Standards. (適用規範)
- 6.0 Mechanical Performance. (機械性能)
- 7.0 Electrical Performance. (電氣性能)
- 8.0 Environmental Performance. (環境性能)
- 9.0 Insertion Force (I.F.) & Withdrawal Force (W.F.) for user reference(嵌入力與拔出力規格值)
- 10.0 Remark (備註).

REV. (版次)	Revision Record (改版變更原因)	Date(日期)	ECN No.
C	1. 修改適用電線Flat Cable規格 2.增加耐久性 及溫升 3.刪除硫化氫 4.修正(EIA-364) 參考規範 5 依安規認證增列額定電壓	2011/10/03	EC2011-10-003
D	IDC Socket 區分為二 Dual Beam Contacts 料號 JS-ID2543BG ; JS-ID2543SBG Single Beam Contacts 料號 JS-ID2543BGC ; JS-ID2543SBGC	2011/12/13	EC2010-12-006
E	新增料號 JS-ID2543BGC2 ; JS-ID2543SBGC2 以及修改 Withdrawal Force :Per Pin 0.03kgx CKT	2012/06/21	EC2012-06-011
F	增列電鍍選項 G ; G1 ; G2	2012/06/26	EC2012-06-013
G	IDC Socket 雙點接觸料號 JS-ID2543BGX ; JS-ID2543SBGX 取消	2012/07/25	EC2012-07-012
H	增列JS-ID2543BGX料號	2012/10/02	EC2012-10-002
I	1 增訂Wave Peak Soldering In- Process Temperature Profile 2.修訂Solder Ability 附註Tin Plated : 95% / Gold Plated : 75%	2013/12/05	EC2013/12/005
J	1. 增訂 Finish(表面鍍層)G0 選項 , 及修改 G , G1 ,G2 鍍層材質定義 2.參照 Operating Temp 增訂 Cold 耐寒試驗(Low Temperature) 及增訂 Thermal Aging 高溫老化試驗 Temperature(溫度) : 105±2℃	2014/05/30	EC2014/05/030
K	修訂8.10.1 項 Temperature Profile Temperature)	2015/02/26	EC2015-02-026
L	修訂1.0 Part number XXx2為XX, 修訂9.1 Circuits XXx2為XX	2022/07/21	EC2022-07-002



喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
 7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
 TAMSHUI, TAIPEI, TAIWAN, R.O.C.



Certificate No:TS 622434 FM 587490

TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677

http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw

Type Document	Product Specification	Revised /Edition	K
Date Issued	2010/03/05	Data Revised	2022/07/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			Engineering Dept.

1.0 Product Name/Part Number & Drawing Number(產品名稱 / 產品型號及圖面型號):

Product Name(產品名稱)		Part Number(零件型號)	Drawing Number(圖面型號)
IDC Socket	JS-ID2543BGXC2 / SBGXC2 	Two Piece Type 單接觸點	JS-ID2543BGXC2-XX
	JS-ID2543BGXC / SBGXC 	兩件式 Type 雙接觸點	JS-ID2543BGXC-XX
	JS-ID2543BGX/ SBGX 	Three Piece Type , 單接觸點	JS-ID2543SBGXC2-XX
		三件式 Type , 單接觸點	JS-ID2543SBGXC-XX
		三件式 Type , 雙接觸點	JS-ID2543SBGX-XX
	Box Header with Latch(牛角)		Straight(直立式)
Right Angle (歐式)			JS-1200WR-XXx2X / JS-1200WR-XXx2(A)

Note: (xx) The number of the circuits.

2.0 Construction/Dimensions/Material & Surface Finish(材質以及表面鍍層):

Part Name(零件名稱)		Material(材質)	Surface Finish(表面鍍層)
IDC Socket (電線端刺破型 連接器)	Contacts (導體)	JS-ID2543BGXXX ; JS-ID2543SBGXXX	Tin Plated over all , Gold on Contact Area
		JS-ID2543BG0XX ; JS-ID2543SBG0XX	Tin Plated over all , Gold 15u" on Contact
		JS-ID2543BG1XX ; JS-ID2543SBG1XX	Gold Flash over all
		JS-ID2543BG2XX ; JS-ID2543SBG2XX	Gold Flash over all ,Gold 15u" on Contact
Base (膠座)		PBT+30%Glass Fiber	UL 94V-0
Box Header with Latch(牛角)	Square Pin (方型導體)		Brass
	Base (膠座)	With Long Latch 長卡榫	PBT
		With Short Latch 短卡榫	

3.0 Characteristic(產品特性):

Item(項目)	Standard(標準規範)
3.1 額定電流 Rated Current	1A AC/DC With AWG #28 is applied(相對適用於美國電線規格 UL2651 AWG #28)
3.2 額定電流 Rated Voltage	250V AC/DC
3.3 Ambient Temperature Range 環境與操作溫度範圍	(操作使用溫度與濕度範圍) Operating Temp.: -40℃~+105℃ ; 85% R.H. Max Including 30℃ Terminal Temperature Rise at rated Current , (包括定額電流內 , 端子所產生 30℃以下溫昇)



喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
 7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
 TAMSHUI, TAIPEI, TAIWAN, R.O.C.
 TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677



Certificate No: TS 622434 FM 587490

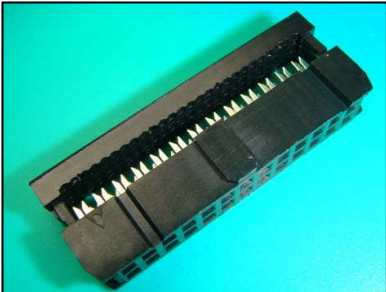
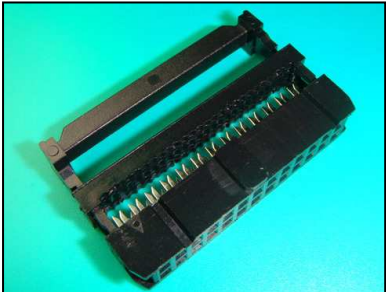
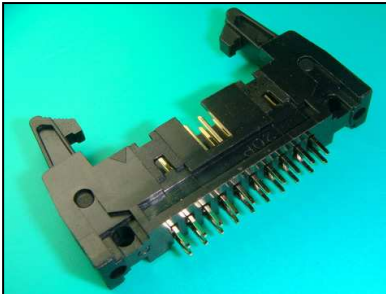
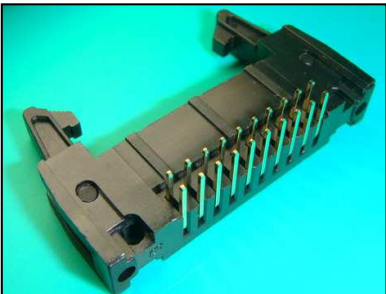
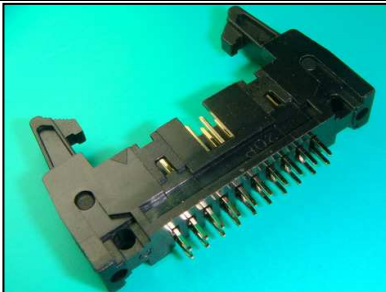
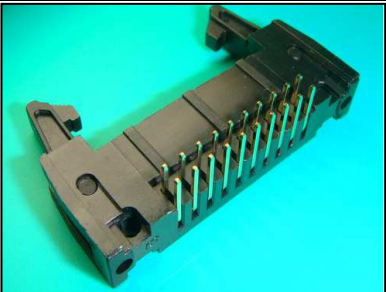
<http://www.chyaoshiunn.com.tw> E-mail: cs@chyaoshiunn.com.tw

Type Document	Product Specification	Revised /Edition	L
Date Issued	2010/03/05	Data Revised	2022/7/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			Engineering Dept.

3.4	Applicable Wire 適用電線	3.4.1 排線型號 Conductor Construction Size : Flat Cable AWG #28 (UL2651)
		3.4.2 排線絕緣體外徑 Flat Cable Insulation O.D.: 0.90±0.10mm
3.5	Storage of Package 包裝未拆封之保存	Temperature and Humidity Condition 溫度濕度條件
		Temperature 溫度 : -10°C~+40°C Percentage Humidity 相對濕度 : 70 % Max
3.6	Floor Life 拆封後使用期限	Term 保存期限 1 Year
3.6		Floor Life 拆封後使用期限 3 Months

Note: 適用電路板厚度 Applicable Printed Circuit Board Thickness: 1.6 mm

4.0 Specimen(樣本圖示) :

Part Name / Part Number/ Picture or Photograph 零件名稱 / 零件型號 / 樣本圖示			
IDC Socket JS-ID2543BGXXX Two Piece Type		IDC Socket JS-ID2543SBGXXX Three Piece Type	
Box Header With Long Latch Straight JS-1200WS		Box Header With Long Latch Right Angle JS1200WR	
Box Header With Short Latch Straight JS-1200WS-xx(A)		Box Header With Short Latch Right Angle JS1200WR-xx(A)	

5.0 Applicable Standards(適用規範):

ANSI/EIA 364 ; EIA/ECA 364 Testing method for electrical connectors.

電子連接器，所適用之 ANSI/EIA 364 ; EIA/ECA 364 測試規範



喬訊電子工業股份有限公司

CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.

7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.

TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677

http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw



Certificate No:TS 622434 FM 587490

Type Document	Product Specification	Revised /Edition	L
Date Issued	2010/03/05	Data Revised	2022/07/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			Engineering Dept.

6.0 Mechanical Performance(機械性能):

Item(項目)	Test Condition(測試條件)	Requirement (規格)
6.1 Insertion & Withdrawal Force 嵌入力與拔出力	Insert and withdrawal with connectors at the speed rate of 25.4±3mm /minute 連接器兩端勘合，以每一分鐘 25.4 ± 3 mm 的速率，作嵌入與拔出往返測試 (EIA/ECA 364-13D) (Excluding Plastic Latch 不包含膠座活動卡榫結合力)	Refer to 9.1 Table1. 參照第 9.1 項 表格 1
6.2 Square Pin Retention Force(in Base) 方型導體與膠座保持力	Axial pullout force on the square pin in the base at the speed rate of 25.4 ± 3 mm per minute. 對於已經存在於膠座當中方型導體，施以每一分鐘 25.4±3 mm 速率之軸向拔出力 (EIA/ECA 364-29C)	單一接觸點 Per Contact 最小容許值 1.2kgf/Min.

7.0 Electrical Performance(電氣性能) :

Item(項目)	Test Condition(測試條件)	Requirement(規格)
7.1 (Low –Signal Level) Contact Resistance (低階信號) 接觸阻抗	A maximum voltage of 20mV and a maximum current of 100mA are applied to the mate connector. 以組合狀態下連接器，於其兩端施以最大測試電壓 20mV 以及最大測試電流 100mA (EIA/ECA 364-23C) (Does not include wire resistance 不包含電線阻抗)	Contact Resistance: 20 milliohms Max. 最大容許值. 20 毫歐姆
7.2 Insulation Resistance 絕緣阻抗	Apply 500V D/C for 1 minute between adjacent contacts to measure the insulation resistance. 對相鄰兩接觸導體，於一分鐘時間內施予 500V D/C 電壓，並量測其間絕緣阻抗值 (EIA 364-21C)	Insulation Resistance: Initial1000 megohms Min 最初容許值. 1000 兆歐姆
7.3 Withstanding Voltage 耐電壓	Apply 1000V A/C (rms) for 1 minute and the leakage current shall not exceed 0.5mA to the adjacent terminal and ground of the mate connectors. 以組合狀態下連接器，於其相鄰兩導體末端各施以電壓 1000V A/C (實效值) 時間 1 分鐘，且漏電流必須小於 0.5mA (毫安培) (EIA 364-20C)	No breakdown or flashover. 無損毀或者產生火花

8.0 Environmental Performance(環境性能) :

Item(項目)	Test Condition(測試條件)	Requirement (規格)
8.1 Durability 耐久性	Mate Connectors up 50 Cycles at a Maximun rate of 10 cycles Per minute prior to environmental test 以組合狀態下連接器且未經環境測試，依每分鐘內進行10次嵌入與拔出之最大速率，連續50次嵌入與拔出往返測試 (EIA/ECA 364-09C)	(After the test) Contact resistance : 經耐久性試驗後接觸阻 抗 : 30 mΩ Max
8.2 Temperature Rise (Via Current Cycling) 溫昇(經由電流循環操作)	Mate connector . measure the temperature rise of contact when the maximum rated current is passed 以組合狀態下連接器，通過最大容許電流 量測其導體溫度上昇值 (EIA 364-70B Conditions 1 . Method 1)	Mate connectors Temperature Rise: +30°C/Max. 組合狀態下連接器溫度上 昇最大容許值 +30°C



Type Document	Product Specification	Revised /Edition	L
Date Issued	2010/03/05	Data Revised	2022/07/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			Engineering Dept.

Item(項目)	Test Condition(測試條件)	Requirement(規格)
8.3 Vibration 耐振動	<p>A mated connector shall be mounted on a printed Circuit board and subjected to a vibration test of the following conditions. During the test, test current continuity shall be checked. After the test, contact resistance shall be measured.</p> <p>以組合狀態下連接器焊接於電路板作為試驗樣品,依照隨附如下規格要求,進行耐振動試驗,試驗過程中確認是否產生不連續電流(斷電)現象,並於試驗過後量測其接觸阻抗。</p> <p>(EIA/ECA 364-28E-Condition I)</p> <p>Frequency(頻率): 10~55~10 Hz/minute.</p> <p>Amplitude(振幅): 1.5 mm P-P</p> <p>Direction(方向): 1. Axis of up and down.上下軸向(Y軸) 2. Axis of right the left. 左右軸向(X軸) 3. Axis of front and back.前後軸向(Z軸)</p> <p>Period(週期): 2 hours for each direction. (每一個軸向持續 2 小時)</p>	<p>Initial Contact Resistance : 20 milliohms Max. 接觸阻抗最初容許值 20 毫歐姆</p> <p>(After the test) Contact Resistance: 30 milliohms Max. 經耐振動試驗後接觸阻抗 最大容許值 30 毫歐姆</p> <p>No discontinuity current is longer than 1 microsecond. 電流中斷現象, 時間不可多於 1 微秒</p>
8.4 Humidity (Steady State) 恆溫恆濕	<p>A mated connector shall be placed in a humidity chamber of the following conditions. After the test, leave the specimen at room temperature for 1~2 hours before the contact resistance, the insulation resistance and the dielectric withstanding voltage shall be measured.</p> <p>以組合狀態下連接器放置於恆定溫度與濕度的空間,依照隨附如下規格要求,進行恆溫恆濕試驗,經試驗過後將樣品置於室溫 1~2 小時,再量測其接觸阻抗、絕緣阻抗、以及耐電壓測試。</p> <p>(EIA 364-31B Conditions II . Method A)</p> <p>Temperature(溫度): 40±2°C.</p> <p>Relative Humidity(相對濕度): 90%~95% (RH).</p> <p>Period(週期): 96 hours continuously. (持續 96 小時)</p>	<p>(After the test) Contact Resistance: 30 milliohms Max. 經恆溫恆濕試驗後接觸阻抗 最大容許值. 30 毫歐姆</p> <p>(After the test) Insulation Resistance : 500 Megohms Min. 經恆溫恆濕試驗後絕緣阻抗 最小容許值. 500 兆歐姆</p> <p>(After the test) Withstanding Voltage: 1000V A/C for 1 minute 經恆溫恆濕試驗後測耐電壓: 每分鐘 1000 伏特 A/C</p>



喬訊電子工業股份有限公司

CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.

7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
TAMSHUI, TAIPEI, TAIWAN, R.O.C.

TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677

http://www.chyaoshiunn.com.tw E-mail:cs@chyaoshiunn.com.tw



Certificate No:TS 622434 FM 587490

Type Document	Product Specification	Revised /Edition	L
Date Issued	2010/03/05	Data Revised	2022/07/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			Engineering Dept.

Item(項目)		Test Condition(測試條件)	Requirement(規格)
8.5	Thermal Shock 冷熱衝擊	<p>A mated connector shall be subjected to a thermal shock test of the following conditions. After the test, leave the specimen at room temperature for 1~2 hours before the contact resistance, the insulation resistance and the dielectric withstanding voltage shall be measured.以組合狀態下連接器作為試驗樣品,依照隨附如下規格要求,進行冷熱衝擊試驗,經試驗過後將樣品置於室溫 1~2 小時,再量測其接觸阻抗、絕緣阻抗、以及耐電壓測試。</p> <p>One Cycle Consists Of: (EIA/ECA 364-32D Conditions I . Method A)</p> <p>-55 +0/-3°C for 30 minutes. → Room Temp.5 minutes 85+3/-0°C for 30 minutes. → Room Temp.5 minutes</p> <p>Total Cycles: 5 Cycles. 以-55+0/-3°C溫度持續 30 分鐘, 經室溫 5 分鐘, 而後再以 85+3/-0°C溫度持續 30 分鐘, 再經室溫 5 分鐘, 構成一次冷熱循環, 總計循環次數 5 次。</p>	<p>Same as paragraph 8.4 同 8.4 章節</p>
8.6	Cold 耐寒試驗 (Low Temperature)	<p>A mated connector shall be placed in a cold chamber of the following conditions. After the test, leave the specimen at room temperature for 1~2 hours before the contact resistance shall be measured. 以組合狀態下連接器放置於低溫空間內, 依照隨附如下規格要求, 進行耐寒試驗, 經試驗過後將樣品置於室溫 1~2 小時,再量測其接觸阻抗。</p> <p>Temperature(溫度): -40±3°C. (EIA 364-59A Procedure 4)</p> <p>Period(週期): 96 hours continuously . (持續 96 小時)</p>	<p>Initial Contact Resistance : 20 milliohms Max. 接觸阻抗最初容許值 20 毫歐姆</p> <p>(After the test) Contact Resistance : 30 milliohms Max. . 經耐寒試驗後接觸阻抗 最大容許值. 30 毫歐姆</p>
8.7	Salt Spray 鹽水噴霧	<p>A mated connector shall be subjected to a Salt Spray test of the following conditions. After the test , the specimen shall be washed with running water and dried naturally before the measurement of contact resistance. 以組合狀態下連接器作為試驗樣品, 依照隨附如下規格要求, 進行鹽水噴霧試驗 , 試驗過後將樣品用清水沖洗並經過自然風乾, 而後量測其接觸阻抗。</p> <p>Density(鹽水密度): 5 % in weight. (EIA 364-26B Conditions B)</p> <p>Temperature(溫度): 35±2°C. Period(週期): 48 hours</p>	<p>Initial Contact Resistance : 20 milliohms Max. 接觸阻抗最初容許值:20 毫歐姆</p> <p>(After the test) Contact Resistance: 30 milliohms Max. 經鹽水噴霧試驗後接觸阻抗 : 最大容許值. 30 毫歐姆</p>



喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
 7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
 TAMSHUI, TAIPEI, TAIWAN, R.O.C.
 TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677



Certificate No:TS 622434 FM 587490

<http://www.chyaoshiunn.com.tw> E-mail:cs@chyaoshiunn.com.tw

Type Document	Product Specification	Revised /Edition	L
Date Issued	2010/03/05	Data Revised	2022/07/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			Engineering Dept.

Item(項目)		Test Condition(測試條件)	Requirement(規格)
8.8	Thermal Aging 高溫老化試驗	A mated connector shall be placed in a heat oven of the following conditions. After the test, leave the specimen at room temperature for 1~2 hours before the contact resistance shall be measured. 以組合狀態下連接器放置於加熱烤箱當中，依照隨附如下規格要求，進行高溫老化試驗，經試驗過後將樣品置於室溫 1~2 小時，再量測其接觸阻抗。 (EIA 364-17B Conditions 4 .Method A) Temperature(溫度): 105±2℃. Period(週期): 96 hours continuously . (持續 96 小時)	Initial Contact Resistance : 20 milliohms Max. 接觸阻抗最初容許值:20 毫歐姆 (After the test) Contact Resistance : 30 milliohms Max. . 經高溫老化試驗後接觸阻抗 最大容許值. 30 毫歐姆
8.9	Solder Ability 焊錫性	Fluxed soldering section of header shall be dipped in solder of the following conditions. 將連接器 pin 針基板嵌入端，接觸熱溶狀錫料，依照隨附如下規格要求，進行焊錫性試驗 (EIA 364-52B) Solder Temperature (焊錫溫度): 245 ± 5℃. Immersion Period (沉浸週期): 3 ±0.5 Seconds (操作方式): 零件焊錫位置，距離導體末端 1.5mm Method : 1.5mm from square pin tip	Solder entirely (Tin Plated : 95% / Gold Plated : 75%) of immersed area must show no voids or pinholes. 焊料覆蓋面積必須達到 (鍍錫 95% / 鍍金 75%)， 而且不能產生氣孔或空隙
8.10	Resistance to Soldering Heat 焊錫耐熱性	By Wave soldering 波焊適用溫度範圍 Refer to temperature profile 請參考 8.10.1 溫度曲線圖 By soldering iron 手工烙鐵焊錫適用溫度範圍： 350 ± 5℃ 5±0.5 Seconds. (操作方式): 零件焊錫位置，距離導體末端 1.5mm Method : 1.5mm from square pin tip (EIA/ECA 364-56C Procedure 3. Conditions A)	No deformation or damage. 不可有變形或損壞

Notes : Flowing Mixed Gas (EIA 364-65A) shall be conduct by Customer request 混合流動氣體測試依照客戶需求



喬訊電子工業股份有限公司
CHYAO SHIUNN ELECTRONIC INDUSTRIAL LTD.
 7FL., NO.17, LANE 3, SEC.1 CHUNG CHENG EAST RD.,
 TAMSHUI, TAIPEI, TAIWAN, R.O.C.
 TEL: 886-2-2629-9955 (REP) FAX: 886-2-2626-6677

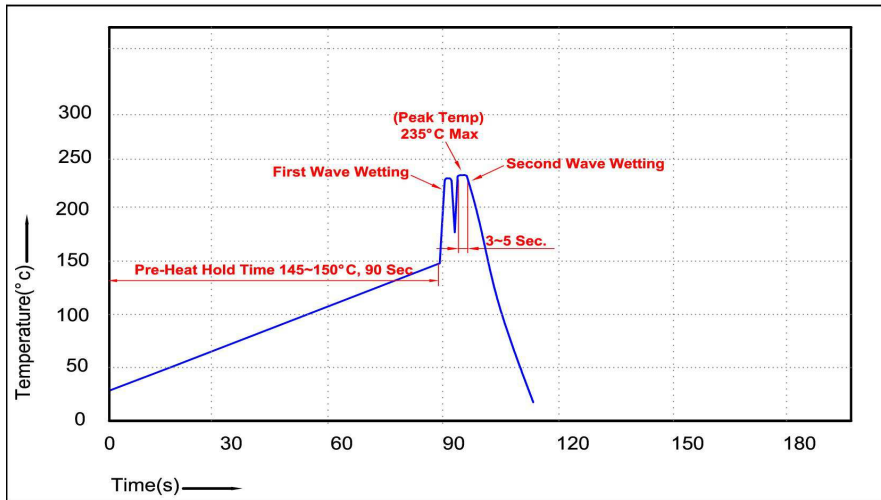


Certificate No: TS 622434 FM 587490

http://www.chyaoshiunn.com.tw E-mail: cs@chyaoshiunn.com.tw

Type Document	Product Specification	Revised /Edition	L
Date Issued	2010/03/05	Data Revised	2022/07/21
Subject: JS-ID2543BGC/SBGC JS-ID2543BGC2/SBGC2 JS-1200WS JS-1200WR			Issued By:
Pitch: 2.54mm DIP Series Flat Cable to Board Connector			Engineering Dept.

8.10.1 Temperature Profile(溫度曲線圖) / Wave Peak Soldering In- General Process 波焊一般制程：



9.0 Tables & Attachments

9.1 Table 1. Insertion Force (I.F.) & Withdrawal Force (W.F.) for user reference:

Unit : Kg/f

No. of Circuits 極數	AT INITIAL 首次嵌入與拔出(初始值)			No. of Circuits 極數	AT INITIAL 首次嵌入與拔出(初始值)		
	I.F. (MAX) 嵌入力	W.F. (MIN) 拔出力			I.F. (MAX) 嵌入力	W.F. (MIN) 拔出力	
	6	1.80			0.18	26	
8	2.40	0.24	30	9.00	0.90		
10	3.00	0.30	34	10.20	1.02		
12	3.60	0.36	40	12.00	1.20		
14	4.20	0.42	42	13.20	1.32		
16	4.80	0.48	50	15.00	1.50		
20	6.00	0.60	60	18.00	1.80		
24	6.60	0.66	64	19.20	1.92		

10.0 Remark(備註) : Any change or revision for the product specification will not be announced in advance.

Please contact our sales representative for the latest information.

有關規格書內容經變更或改版，如未能夠及時發佈與通知，煩請連絡我司業務人員以提供產品最新資訊

Reviewed: Tom Shih **Approved:** Erin Chou **Verified:** Eddie